

PIC16(L)F1824/1828 Family Silicon Errata and Data Sheet Clarification

The PIC16(L)F1824/1828 family devices that you have received conform functionally to the current Device Data Sheet (DS41419A), except for the anomalies described in this document.

The silicon issues discussed in the following pages are for silicon revisions with the Device and Revision IDs listed in [Table 1](#). The silicon issues are summarized in [Table 2](#).

The errata described in this document will be addressed in future revisions of the PIC16(L)F1824/1828 silicon.

Note: This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated in the last column of [Table 2](#) apply to the current silicon revision (**A3**).

Data Sheet clarifications and corrections start on page 7, following the discussion of silicon issues.

The silicon revision level can be identified using the current version of MPLAB® IDE and Microchip's programmers, debuggers, and emulation tools, which are available at the Microchip corporate web site (www.microchip.com).

For example, to identify the silicon revision level using MPLAB IDE in conjunction with MPLAB ICD 2 or PICKit™ 3:

1. Using the appropriate interface, connect the device to the MPLAB ICD 2 programmer/debugger or PICKit™ 3.
2. From the main menu in MPLAB IDE, select *Configure>Select Device*, and then select the target part number in the dialog box.
3. Select the MPLAB hardware tool (*Debugger>Select Tool*).
4. Perform a "Connect" operation to the device (*Debugger>Connect*). Depending on the development tool used, the part number and Device Revision ID value appear in the **Output** window.

Note: If you are unable to extract the silicon revision level, please contact your local Microchip sales office for assistance.

The DEVREV values for the various PIC16(L)F1824/1828 silicon revisions are shown in [Table 1](#).

TABLE 1: SILICON DEVREV VALUES

Part Number	Device ID ⁽¹⁾	Revision ID for Silicon Revision ⁽²⁾	
		A1	A3
PIC16F1824	10 0111 010x xxxx	1	3
PIC16LF1824	10 1000 010x xxxx	1	3
PIC16F1828	10 0111 110x xxxx	1	3
PIC16LF1828	10 1000 110x xxxx	1	3

- Note 1:** The Device ID is located in the last configuration memory space.
- Note 2:** Refer to the "PIC16F/LF182X/PIC12F/LF1822 Memory Programming Specification" (DS41390) for detailed information on Device and Revision IDs for your specific device.

PIC16(L)F1824/1828

TABLE 2: SILICON ISSUE SUMMARY

Module	Feature	Item Number	Issue Summary	Affected Revisions ⁽¹⁾	
				A1	A3
ADC	ADC Conversion	1.1	ADC Conversion may not complete.	X	
Oscillator	HS Oscillator	2.1	HS Oscillator min. VDD.	X	
Enhanced Capture Compare PWM (ECCP)	Enhanced PWM	3.1	PWM 0% duty cycle direction change.	X	
Enhanced Capture Compare PWM (ECCP)	Enhanced PWM	3.2	PWM 0% duty cycle port steering.	X	
Timer1	T1 Gate Toggle mode	4.1	T1 Gate Flip-Flop does not clear.	X	
ADC	Error Parameters	5.1	Differential and gain error.	X	X
In-Circuit Serial Programming™ (ICSP™)	Low-Voltage Programming	6.1	Bulk Erase not available with LVP.	X	
Clock Switching	OSTS Status Bit	7.1	Remains clear when 4xPLL enabled.	X	X

Note 1: Only those issues indicated in the last column apply to the current silicon revision.

Silicon Errata Issues

Note: This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated by the shaded column in the following tables apply to the current silicon revision (A3).

1. Module: ADC

1.1 Analog-to-Digital Conversion

An ADC conversion may not complete under these conditions:

1. When FOSC is greater than 8 MHz and it is the clock source used for the ADC converter.
2. The ADC is operating from its dedicated internal FRC oscillator and the device is not in Sleep mode (any FOSC frequency).

When this occurs, the ADC Interrupt Flag (ADIF) does not get set, the GO/DONE bit does not get cleared, and the conversion result does not get loaded into the ADRESH and ADRESL result registers.

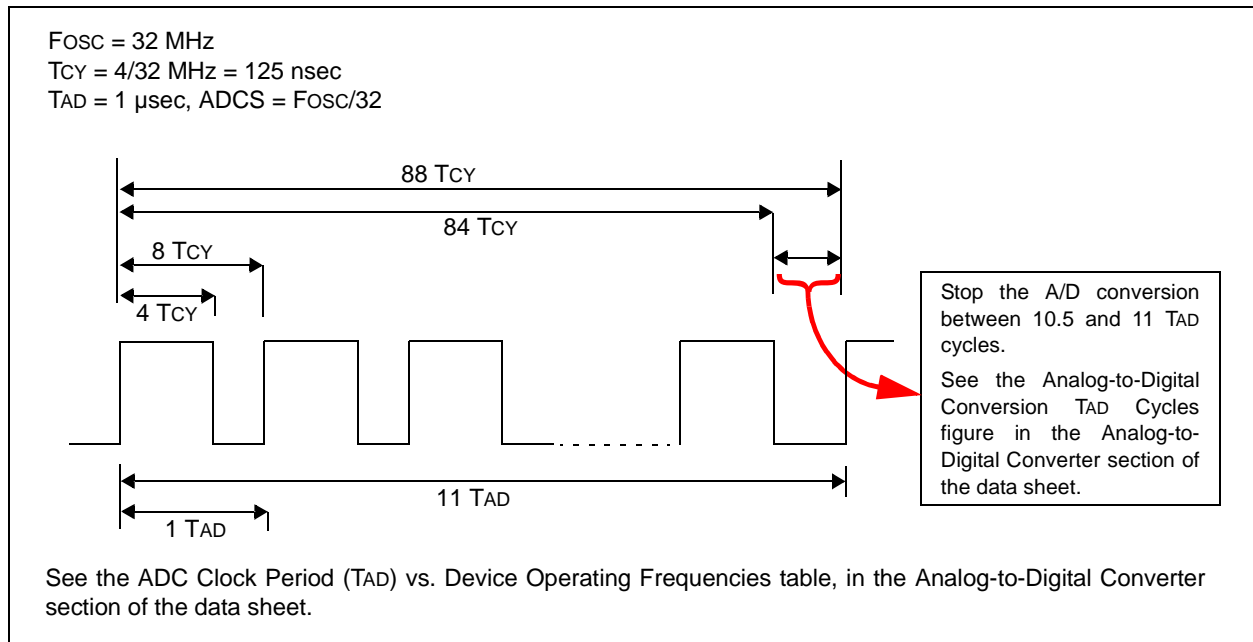
Work around

Method 1: Select the system clock, FOSC, as the ADC clock source and reduce the FOSC frequency to 8 MHz or less when performing ADC conversions.

Method 2: Select the dedicated FRC oscillator as the ADC conversion clock source and perform all conversions with the device in Sleep.

Method 3: This method is provided if the application cannot use Sleep mode and requires continuous operation at frequencies above 8 MHz. This method requires early termination of an ADC conversion. Provide a fixed time delay in software to stop the A-to-D conversion manually, after all 10 bits are converted, but before the conversion would complete automatically. The conversion is stopped by clearing the GO/DONE bit in software. The GO/DONE bit must be cleared during the last 1/2 TAD cycle, before the conversion would have completed automatically. Refer to [Figure 1](#) for details.

FIGURE 1: INSTRUCTION CYCLE DELAY CALCULATION EXAMPLE



PIC16(L)F1824/1828

In Figure 1, 88 instruction cycles (Tcy) will be required to complete the full conversion. Each TAD cycle consists of 8 Tcy periods. A fixed delay is provided to stop the A/D conversion after 86 instruction cycles and terminate the conversion at the correct time as shown in the figure above.

Note: The exact delay time will depend on the TAD divisor (ADCS) selection. The Tcy counts shown in the timing diagram above apply to this example only. Refer to Table 3 for the required delay counts for other configurations.

EXAMPLE 1: CODE EXAMPLE OF INSTRUCTION CYCLE DELAY

```
BSF    ADCON0, ADGO    ; Start ADC conversion
                        ; Provide 86
                        ; instruction cycle
                        ; delay here
BCF    ADCON0, ADGO    ; Terminate the
                        ; conversion manually
MOVF   ADRESH, W       ; Read conversion
                        ; result
```

For other combinations of FOSC, TAD values and Instruction cycle delay counts, refer to Table 3.

TABLE 3: INSTRUCTION CYCLE DELAY COUNTS BY TAD SELECTION

TAD	Instruction Cycle Delay Counts
Fosc/64	172
Fosc/32	86
Fosc/16	43

Affected Silicon Revisions

A1	A3						
X							

2. Module: Oscillator

2.1 HS Oscillator

The HS oscillator requires a minimum voltage of 3.0 volts (at 65°C or less) to operate at 20 MHz.

Work around

None.

Affected Silicon Revisions

A1	A3						
X							

3. Module: Enhanced Capture Compare PWM (ECCP)

3.1 Enhanced PWM

When the PWM is configured for Full-Bridge mode and the duty cycle is set to 0%, writing the PxM<1:0> bits to change the direction has no effect on PxA and PxC outputs.

Work around

Increase the duty cycle to a value greater than 0% before changing directions.

Affected Silicon Revisions

A1	A3						
X							

3.2 Enhanced PWM

In PWM mode, when the duty cycle is set to 0% and the STRxSYNC bit is set, writing the STRxA, STRxB, STRxC and the STRxD bits to enable/disable steering to port pins has no effect on the outputs.

Work around

Increase the duty cycle to a value greater than 0% before enabling/disabling steering to port pins.

Affected Silicon Revisions

A1	A3						
X							

4. Module: Timer1

4.1 Timer1 Gate Toggle mode

When Timer1 Gate Toggle mode is enabled, it is possible to measure the full-cycle length of a Timer1 gate signal. To perform this function, the Timer1 gate source is routed through a flip-flop that changes state on every incrementing edge of the gate signal. Timer1 Gate Toggle mode is enabled by setting the T1GTM bit of the T1GCON register. When working properly, clearing either the T1GTM bit or the TMR1ON bit would also clear the output value of this flip-flop, and hold it clear. This is done in order to control which edge is being measured. The issue that exists is that clearing the TMR1ON bit does not clear the output value of the flip-flop and hold it clear.

Work around

Clear the T1GTM bit in the T1GCON register to clear and hold clear the output value of the flip-flop.

Affected Silicon Revisions

A1	A3						
X							

5. Module: ADC

5.1 ADC Differential and Gain Error Parameters

The differential and gain error parameters are as follows:

Param No.	Sym.	Characteristic	Min.	Typ†	Max.	Units	Conditions
AD03	EDL	Differential Error	—	—	±1.5	LSb	VREF = 3.0V
AD05	EGN	Gain Error	—	—	±2	LSb	VREF = 3.0V

Work around

None.

Affected Silicon Revisions

A1	A3						
X	X						

PIC16(L)F1824/1828

6. Module: In-Circuit Serial Programming™ (ICSP™)

6.1 Bulk Erase Feature not available with Low-Voltage Programming mode

A bulk erase of the program Flash memory or data memory cannot be executed in Low-Voltage Programming mode.

Work around

Method 1: If ICSP Low-Voltage Programming mode is required, use row erases to erase the program memory, as described in the Program/Verify mode section of the Programming Specification. Data memory must be over-written with the desired values.

Method 2: Use ICSP High-Voltage Programming mode if a bulk erase is required.

Note: Only the bulk erase feature will erase program or data memory if code or data protection is enabled. Method 2 must be used if code or data protection is enabled.

Affected Silicon Revisions

A1	A3						
X							

7. Module: Clock Switching

7.1 OSTS Status Bit

When the 4xPLL is enabled, the Oscillator Start-up Time-out Status (OSTS) bit always remains clear.

Work around

None.

Affected Silicon Revisions

A1	A3						
X	X						

Data Sheet Clarifications

The following typographic corrections and clarifications are to be noted for the latest version of the device data sheet (DS41419A):

<p>Note: Corrections are shown in bold. Where possible, the original bold text formatting has been removed for clarity.</p>

None.

PIC16(L)F1824/1828

APPENDIX A: DOCUMENT REVISION HISTORY

Rev A Document (06/2010)

Initial release of this document.

Rev B Document (07/2010)

Revised Module 1.1; Added Module 6.1; Other minor corrections.

Rev C Document (12/2010)

Updated errata to new format; Added Revision A3; Added Module 7.

Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as “unbreakable.”

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights.

Trademarks

The Microchip name and logo, the Microchip logo, dsPIC, KEELOQ, KEELOQ logo, MPLAB, PIC, PICmicro, PICSTART, PIC³² logo, rPIC and UNI/O are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

FilterLab, Hampshire, HI-TECH C, Linear Active Thermistor, MXDEV, MXLAB, SEEVAL and The Embedded Control Solutions Company are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Analog-for-the-Digital Age, Application Maestro, CodeGuard, dsPICDEM, dsPICDEM.net, dsPICworks, dsSPEAK, ECAN, ECONOMONITOR, FanSense, HI-TIDE, In-Circuit Serial Programming, ICSP, Mindi, MiWi, MPASM, MPLAB Certified logo, MPLIB, MPLINK, mTouch, Omniscient Code Generation, PICC, PICC-18, PICDEM, PICDEM.net, PICkit, PICTail, REAL ICE, rLAB, Select Mode, Total Endurance, TSHARC, UniWinDriver, WiperLock and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

All other trademarks mentioned herein are property of their respective companies.

© 2010, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.

 Printed on recycled paper.

ISBN: 978-1-60932-733-0

Microchip received ISO/TS-16949:2002 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEELOQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.

**QUALITY MANAGEMENT SYSTEM
CERTIFIED BY DNV
== ISO/TS 16949:2002 ==**



MICROCHIP

Worldwide Sales and Service

AMERICAS

Corporate Office
2355 West Chandler Blvd.
Chandler, AZ 85224-6199
Tel: 480-792-7200
Fax: 480-792-7277
Technical Support:
<http://support.microchip.com>
Web Address:
www.microchip.com

Atlanta
Duluth, GA
Tel: 678-957-9614
Fax: 678-957-1455

Boston
Westborough, MA
Tel: 774-760-0087
Fax: 774-760-0088

Chicago
Itasca, IL
Tel: 630-285-0071
Fax: 630-285-0075

Cleveland
Independence, OH
Tel: 216-447-0464
Fax: 216-447-0643

Dallas
Addison, TX
Tel: 972-818-7423
Fax: 972-818-2924

Detroit
Farmington Hills, MI
Tel: 248-538-2250
Fax: 248-538-2260

Kokomo
Kokomo, IN
Tel: 765-864-8360
Fax: 765-864-8387

Los Angeles
Mission Viejo, CA
Tel: 949-462-9523
Fax: 949-462-9608

Santa Clara
Santa Clara, CA
Tel: 408-961-6444
Fax: 408-961-6445

Toronto
Mississauga, Ontario,
Canada
Tel: 905-673-0699
Fax: 905-673-6509

ASIA/PACIFIC

Asia Pacific Office
Suites 3707-14, 37th Floor
Tower 6, The Gateway
Harbour City, Kowloon
Hong Kong
Tel: 852-2401-1200
Fax: 852-2401-3431

Australia - Sydney
Tel: 61-2-9868-6733
Fax: 61-2-9868-6755

China - Beijing
Tel: 86-10-8528-2100
Fax: 86-10-8528-2104

China - Chengdu
Tel: 86-28-8665-5511
Fax: 86-28-8665-7889

China - Chongqing
Tel: 86-23-8980-9588
Fax: 86-23-8980-9500

China - Hong Kong SAR
Tel: 852-2401-1200
Fax: 852-2401-3431

China - Nanjing
Tel: 86-25-8473-2460
Fax: 86-25-8473-2470

China - Qingdao
Tel: 86-532-8502-7355
Fax: 86-532-8502-7205

China - Shanghai
Tel: 86-21-5407-5533
Fax: 86-21-5407-5066

China - Shenyang
Tel: 86-24-2334-2829
Fax: 86-24-2334-2393

China - Shenzhen
Tel: 86-755-8203-2660
Fax: 86-755-8203-1760

China - Wuhan
Tel: 86-27-5980-5300
Fax: 86-27-5980-5118

China - Xian
Tel: 86-29-8833-7252
Fax: 86-29-8833-7256

China - Xiamen
Tel: 86-592-2388138
Fax: 86-592-2388130

China - Zhuhai
Tel: 86-756-3210040
Fax: 86-756-3210049

ASIA/PACIFIC

India - Bangalore
Tel: 91-80-3090-4444
Fax: 91-80-3090-4123

India - New Delhi
Tel: 91-11-4160-8631
Fax: 91-11-4160-8632

India - Pune
Tel: 91-20-2566-1512
Fax: 91-20-2566-1513

Japan - Yokohama
Tel: 81-45-471- 6166
Fax: 81-45-471-6122

Korea - Daegu
Tel: 82-53-744-4301
Fax: 82-53-744-4302

Korea - Seoul
Tel: 82-2-554-7200
Fax: 82-2-558-5932 or
82-2-558-5934

Malaysia - Kuala Lumpur
Tel: 60-3-6201-9857
Fax: 60-3-6201-9859

Malaysia - Penang
Tel: 60-4-227-8870
Fax: 60-4-227-4068

Philippines - Manila
Tel: 63-2-634-9065
Fax: 63-2-634-9069

Singapore
Tel: 65-6334-8870
Fax: 65-6334-8850

Taiwan - Hsin Chu
Tel: 886-3-6578-300
Fax: 886-3-6578-370

Taiwan - Kaohsiung
Tel: 886-7-213-7830
Fax: 886-7-330-9305

Taiwan - Taipei
Tel: 886-2-2500-6610
Fax: 886-2-2508-0102

Thailand - Bangkok
Tel: 66-2-694-1351
Fax: 66-2-694-1350

EUROPE

Austria - Wels
Tel: 43-7242-2244-39
Fax: 43-7242-2244-393

Denmark - Copenhagen
Tel: 45-4450-2828
Fax: 45-4485-2829

France - Paris
Tel: 33-1-69-53-63-20
Fax: 33-1-69-30-90-79

Germany - Munich
Tel: 49-89-627-144-0
Fax: 49-89-627-144-44

Italy - Milan
Tel: 39-0331-742611
Fax: 39-0331-466781

Netherlands - Drunen
Tel: 31-416-690399
Fax: 31-416-690340

Spain - Madrid
Tel: 34-91-708-08-90
Fax: 34-91-708-08-91

UK - Wokingham
Tel: 44-118-921-5869
Fax: 44-118-921-5820

08/04/10